



High Energy High Intensity Hadron Beams

<http://care-hhh.web.cern.ch/care-hhh/>



HHH Highlight Talk

Active Techniques to Mitigate the Electron-Cloud Effects in Proton Machines

Frank Zimmermann, CERN

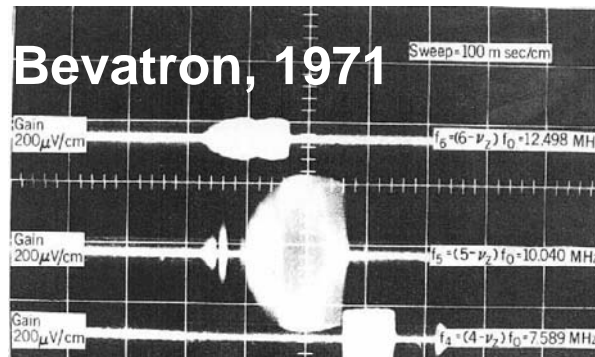
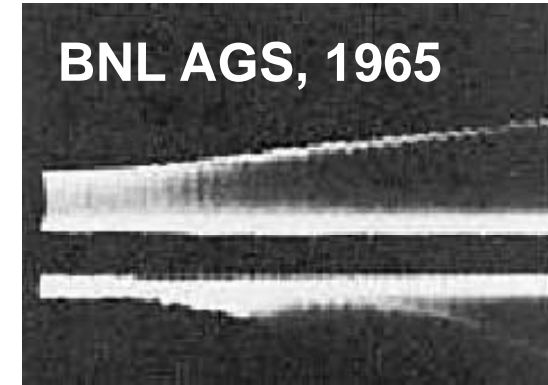
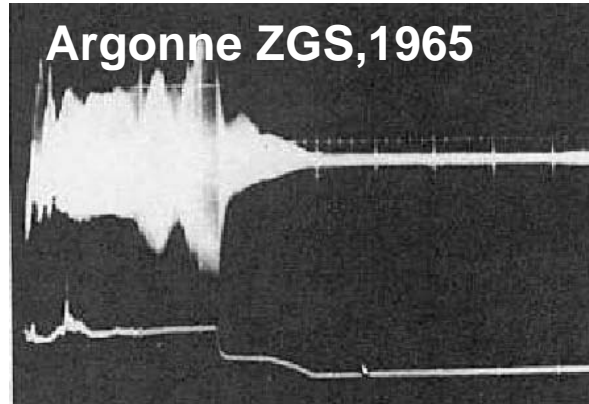
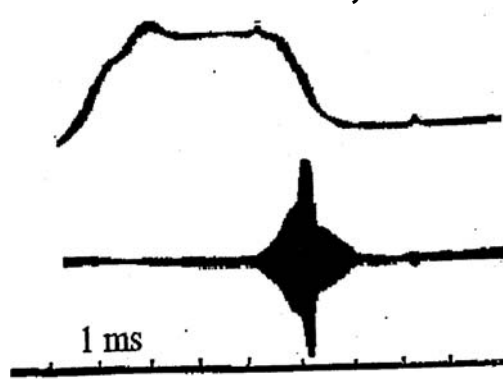
CERN

electron-cloud effects

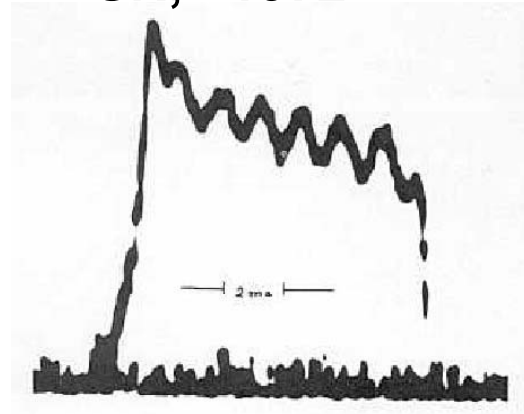
- **pressure rise**
 - interlock, background, beam loss
- **heat load**
 - quench of s.c. magnets
- **coherent tune shift**
 - loss of Landau damping, instabilities
- **single and multi-bunch instabilities**
 - beam loss, emittance growth
- **incoherent tune shift, nonlinear field**
 - poor lifetime, emittance growth

electron-cloud effects seen at almost all p (& e+) accelerators

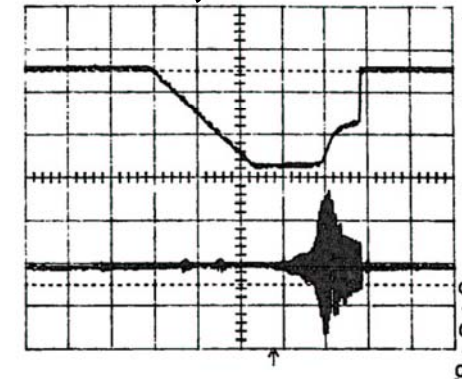
INP Novosibirsk, 1965



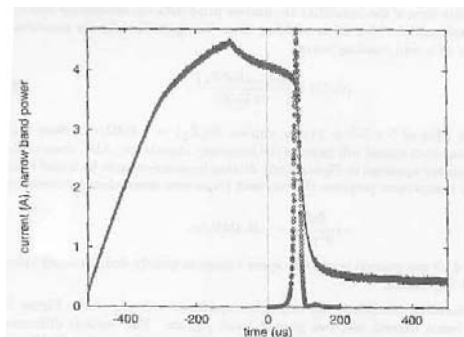
ISR, ~1972



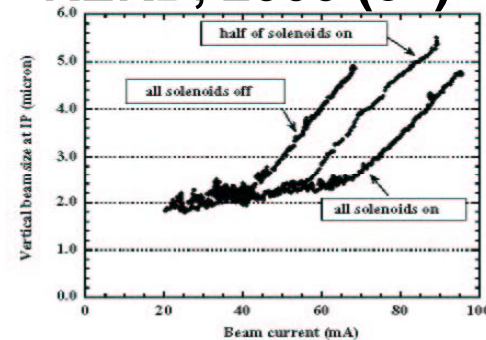
PSR, 1988



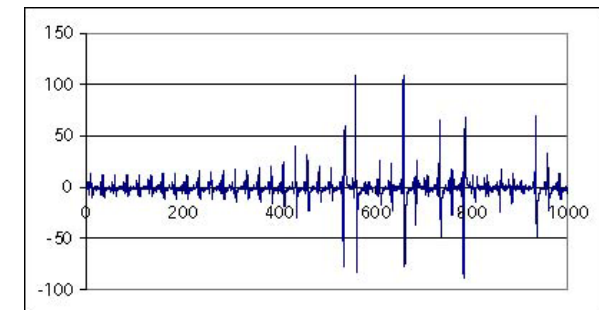
AGS Booster, 1998/99



KEKB, 2000 (e+)



CERN SPS, 2000



origin of electrons

- **ionization of residual gas**

vacuum pressure

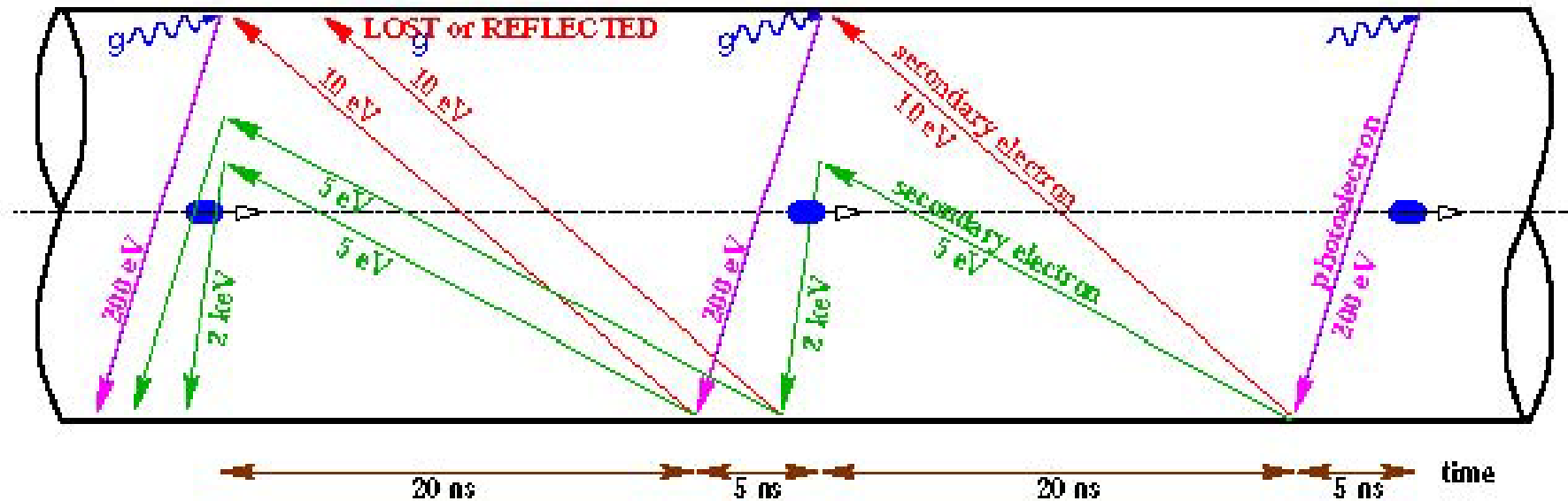
- **photoemission from synchrotron radiation**

spatial distribution of primary and reflected photons, photon reflectivity, photoemission yield

- **avalanche build up of secondary e-
via acceleration in the beam field**

secondary emission yield, surface conditions, conditioning,....

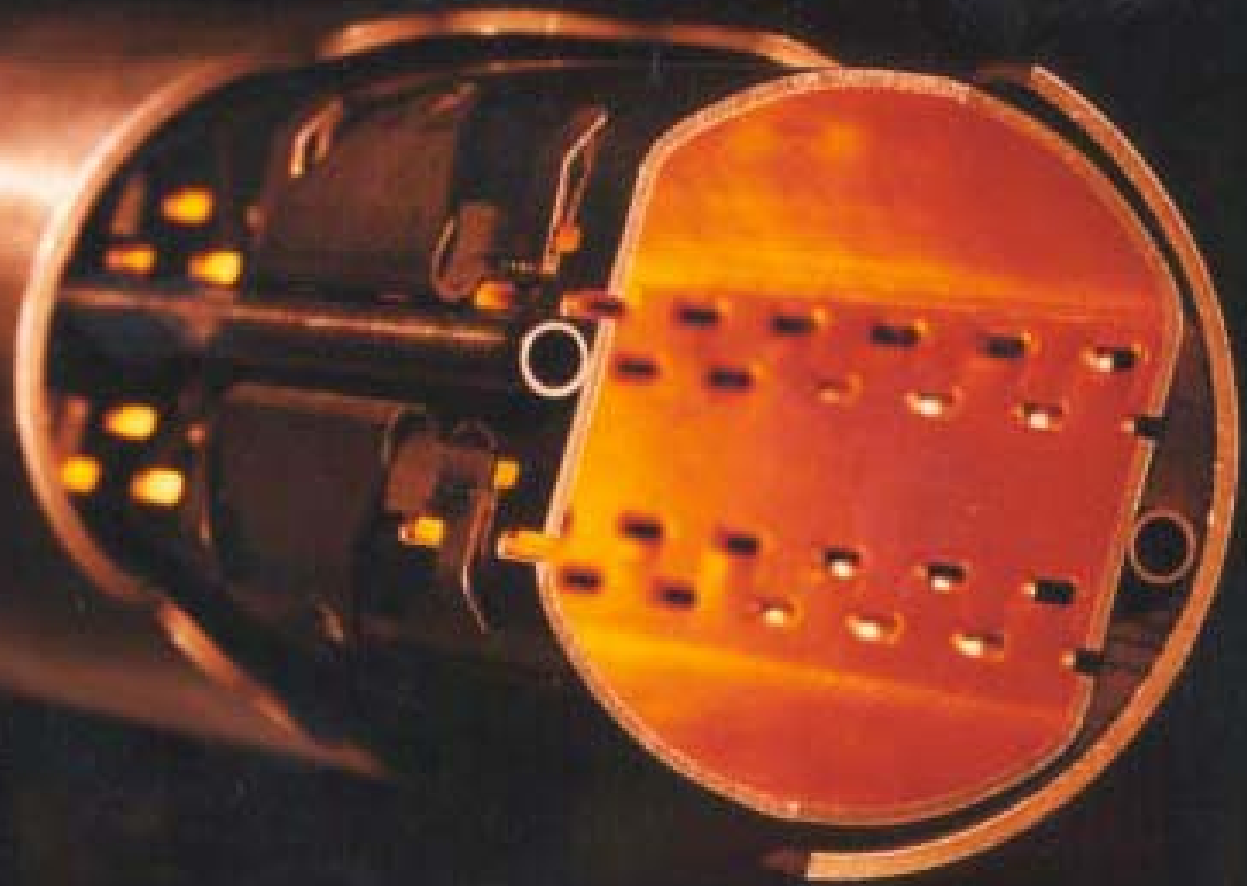
electron cloud in the LHC



schematic of e- cloud build up in the arc beam pipe,
due to **photoemission** and **secondary emission**

[F. Ruggiero]

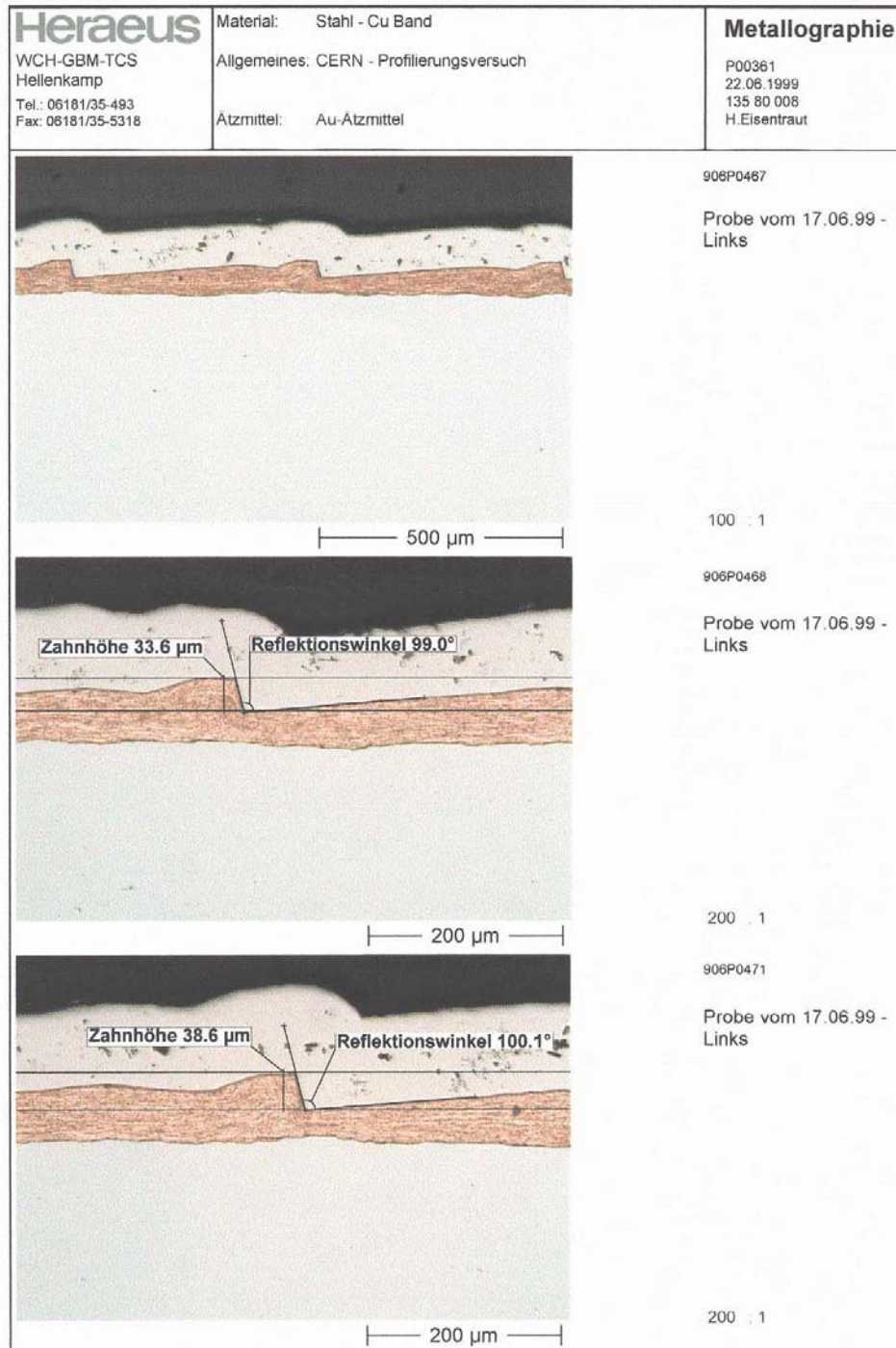
LHC cold vacuum chamber



4-20 K beam screen inside cold bore; pumping slots

LHC strategy against electron cloud ~1997-2002

- 1) **warm sections** (20% of circumference) **coated by TiZrV getter** developed at CERN; low secondary emission; if cloud occurs, ionization by electrons (high cross section ~ 400 Mbarn) aids in pumping & pressure will even improve
- 2) outer wall of **beam screen** (at 4-20 K, inside 1.9-K cold bore) will have a **sawtooth surface** ($30 \mu\text{m}$ over $500 \mu\text{m}$) to reduce photon reflectivity to $\sim 2\%$ so that photoelectrons are only emitted from outer wall & confined by dipole field
- 3) **pumping slots** in beam screen are **shielded** to prevent electron impact on cold magnet bore
- 4) rely on **surface conditioning** ('scrubbing'); commissioning strategy; as a last resort doubling or tripling bunch spacing suppresses e-cloud heat load



sawtooth structure stamped on LHC beam screen

→ reduced photon reflectivity

→ only 2% of photons reflected such that they hit top or bottom of beam screen

courtesy I. Collins, 1999

"beyond LHC" - situation early 2007

- HHH LUMI'06 workshop Valencia showed e-cloud may be severe problem for **new LHC injectors** (PS2, SPS w PS2)
 - Fritz Caspers proposed solution: "**e-cloud killer**" based on enamel coating; established contacts in Germany
 - Warner Bruns (EUROTeV) wrote new e-code "Faktor2" & found novel cure: slots
 - **CARE-HHH & CARE-ELAN** supportive
 - wide resonance from **community**
- ***ECL2 mini-workshop, 1-2 March 2007***

HHH →

APD
Accelerator Physics and
synchrotron Design

CERN, 1-2 March 2007

ECL2

CERN

EUROTeV

ELAN

care-hhh.web.cern.ch/CARE-HHH/ECL2

**Joint CARE-HHH-APD, CARE-ELAN and EUROTEV-WP3
mini-Workshop on Electron Cloud Clearing**

Electron Cloud Effects and Technological Consequences

Organizing committee: **F. Caspers** (CERN), **O. Malyshev** (ASTeC/Cockcroft), **M. Pivi** (SLAC),
W. Scandale (CERN), **D. Schulte** (CERN), **R. Wanzenberg** (DESY), **F. Zimmermann** (CERN)

ECL2 participants

- total: 35
- 16 from CERN (4 AB/ABP, 1 AB/OP, 7 AB/RF, 2 AT-VAC, 2 TS)
- 3 from German enamel industry
- 4 from US (BNL, Cornell, LBNL & SLAC)
- 1 from KEK
- 11 from European research institutes and universities (Astec, LNF, DESY, ANKA, Rostock, CELLS, U.Sannio, ESRF)



CERN-AB-2007-064-ABP

CARE-Conf-07-007-HHH
CARE/ELAN document-2007-006
EUROTeV-Report-2007-060

20 August 2007

Joint CARE-ELAN, CARE-HHH-APD, and EUROTeV-WP3
Workshop on

Electron Cloud Clearing

- Electron Cloud Effects and Technological Consequences

“ECL2”

CERN, Geneva, Switzerland, 1 - 2 March, 2007

PROCEEDINGS

Editors :

F. Caspers

W. Scandale

D. Schulte

F. Zimmermann

GENEVA
2007

ECL2 proceedings

CARE-HHH Conf
CARE/ELAN doc
EUROTeV report
CERN-AB report

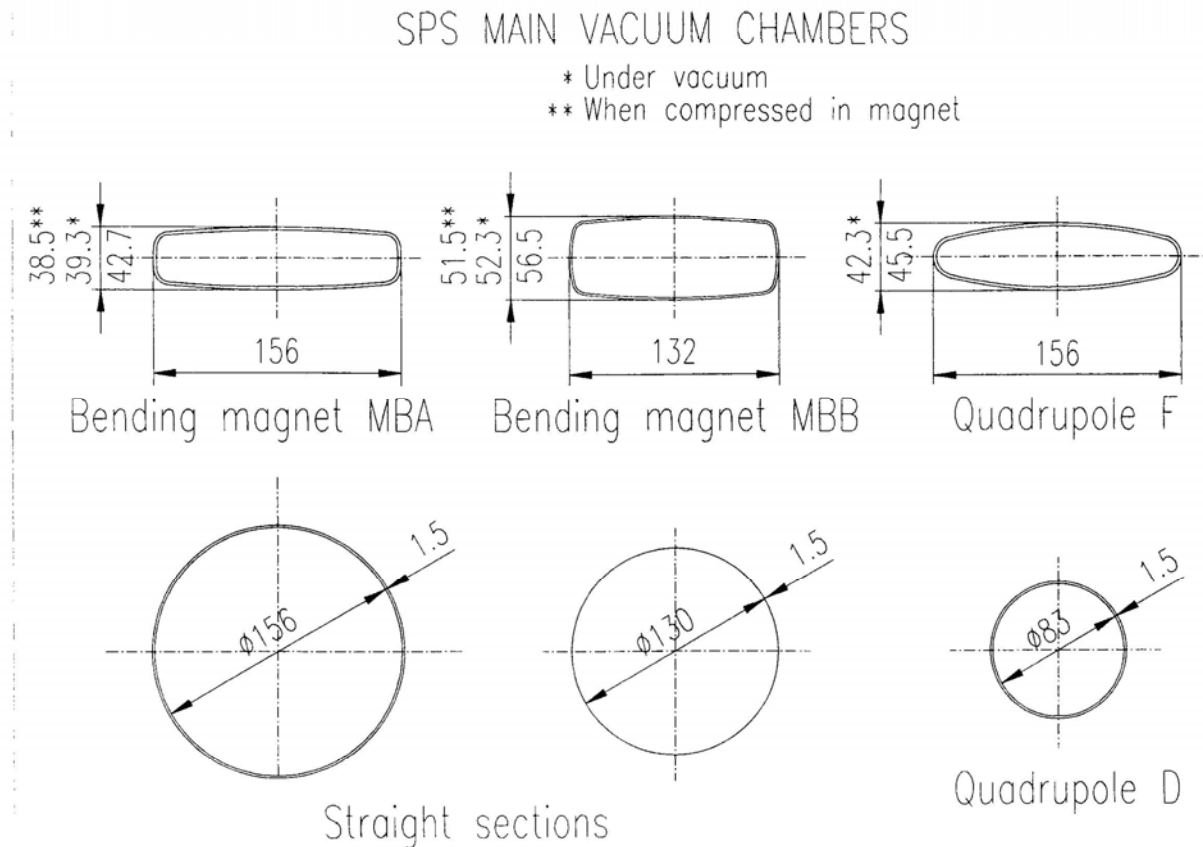
ECL2: solutions against electron cloud

- TiN coating (P. Chiggiato + team, Y. Suetsugu)
- Ti ZrV NEG coating (P. Chiggiato, Y. Suetsugu)
- grooved surfaces (M. Pivi, M. Palmer)
- conventional clearing electrodes
(A. Poncet, M. Zobov)
- **enamel electrodes** (F. Caspers) *New!*
- **slotted vacuum chamber** (W. Bruns) *New!*
- **electrete inserts** (F. Caspers) *New!*

issues: modeling, prototypes, beam experiments, suppression efficiency, impedance, vacuum issues, implications & cost

TiN coating & graphite:

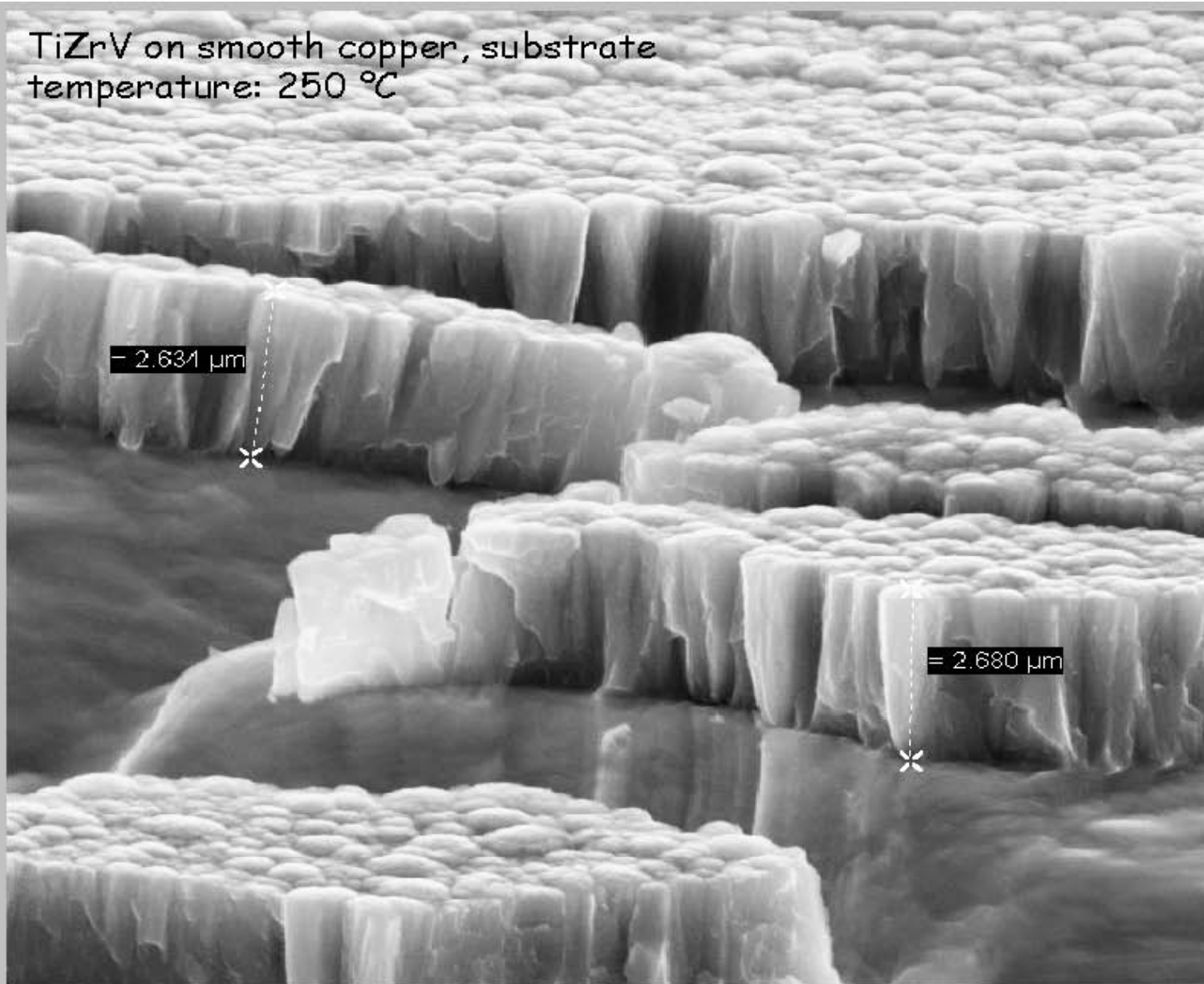
infrastructure for **TiN coating** exists at CERN;
planned testing of coated liners in SPS;
alternative approach: **graphite layer**



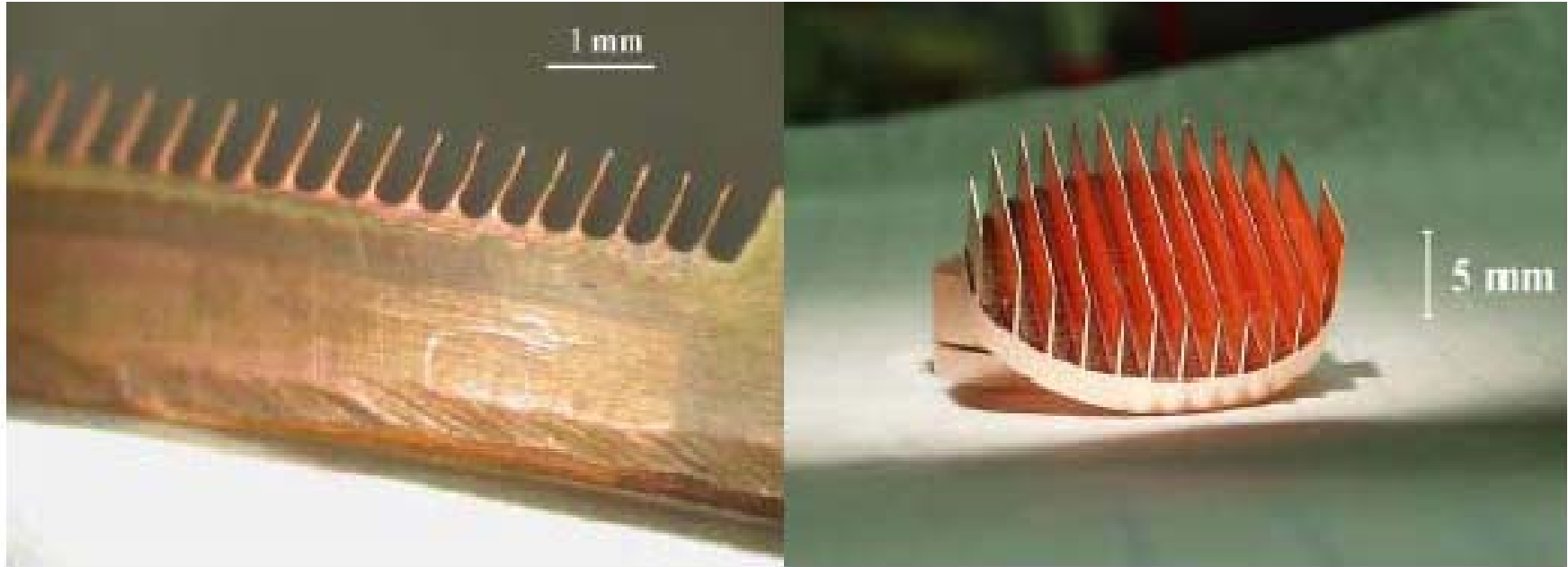
LHC NEG coating (P. Chiggiato, ECL2)



NEG coating on Cu substrate at 250 °C (P. Chiggiato, ECL2)

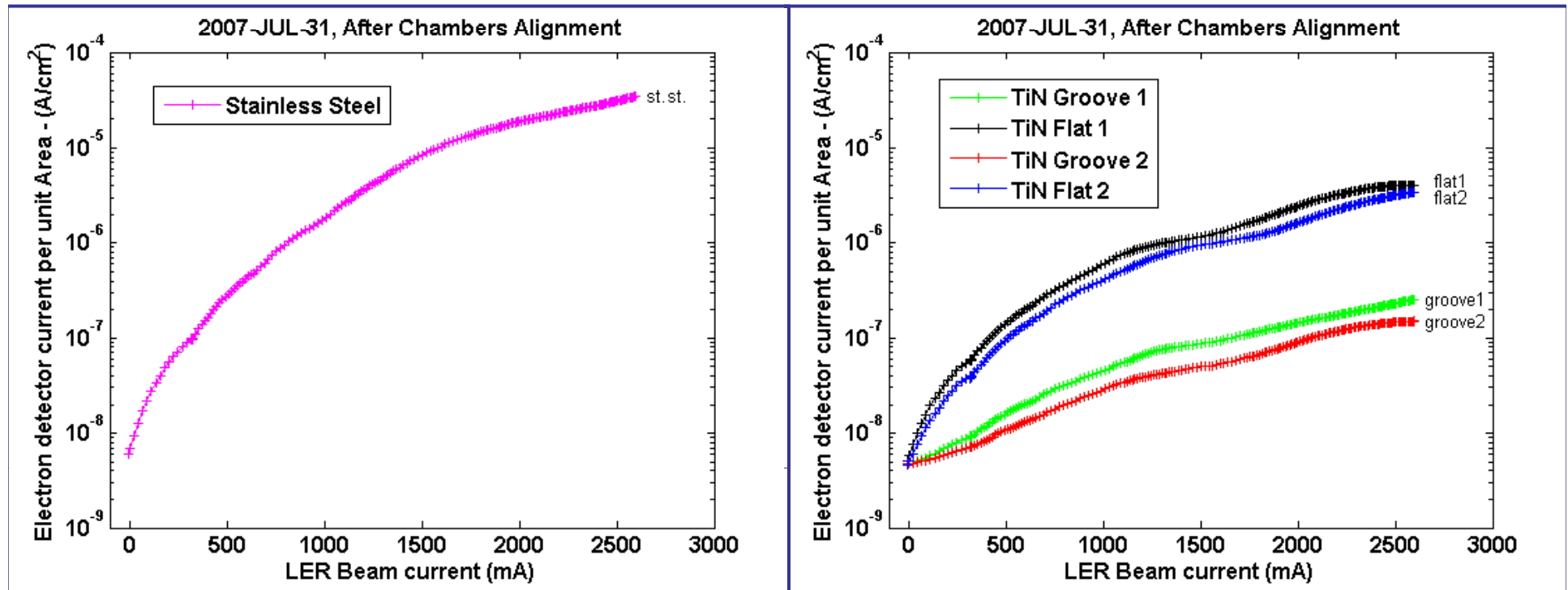


“grooves” (M. Pivi et al, SLAC, ECL2)



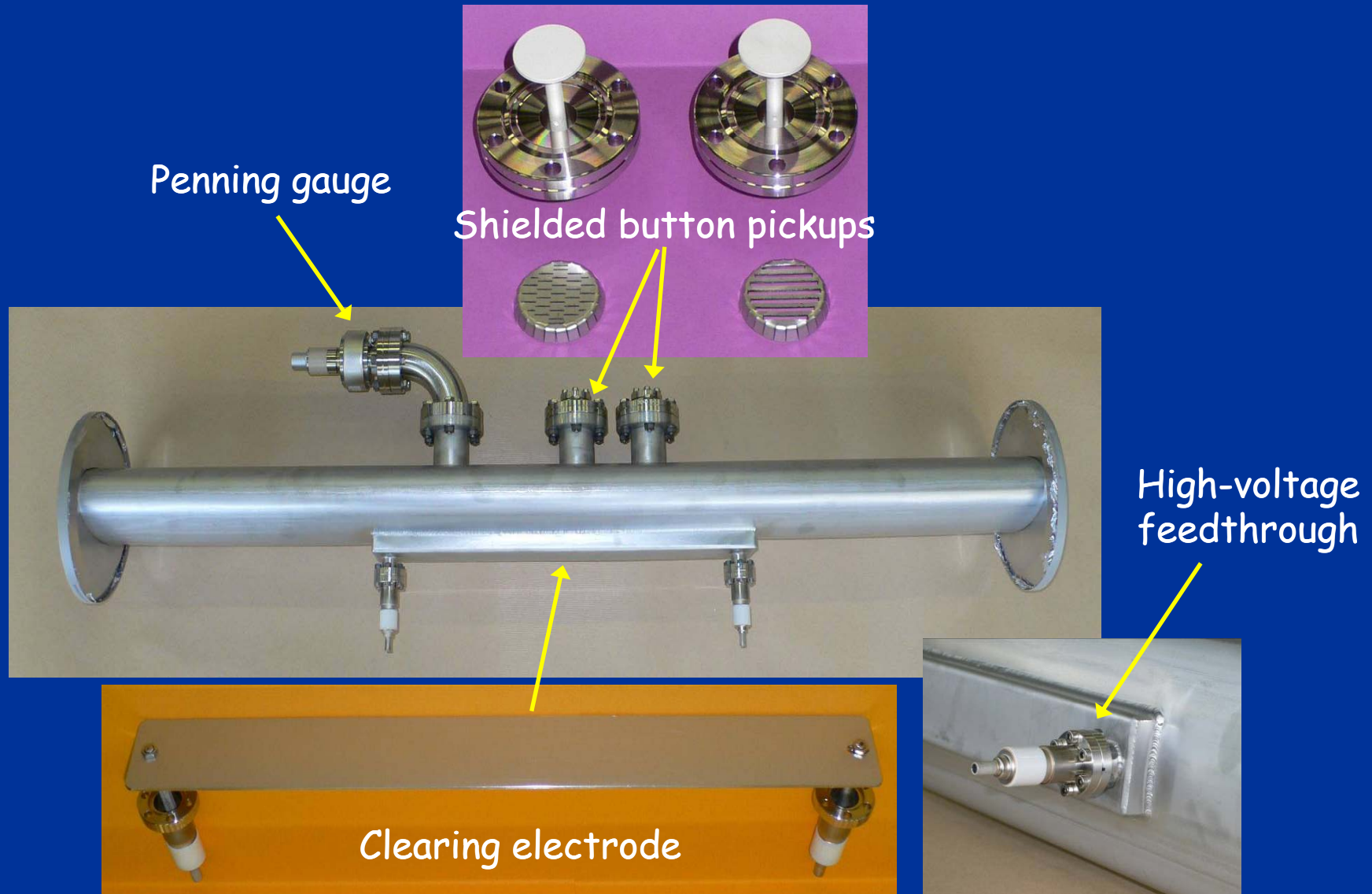
PEP-II tests w. grooved & coated chambers (2007)

- field-free region, 2 chambers with rectangular groove profiles, and 2 regular "flat" or smooth chambers
- same inner diameter, all chambers coated with TiN!



electron signal: grooved TiN-chambers « smooth TiN-chambers « regular stainless steel chamber (M. Pivi)

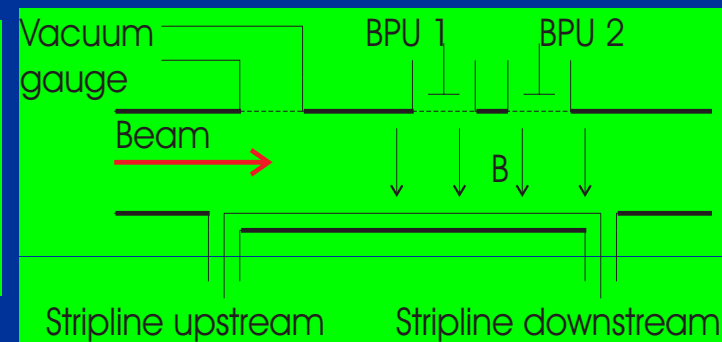
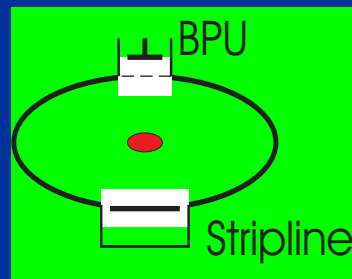
PS e- clearing electrode (2007)



PS e- cloud test bench (2007)

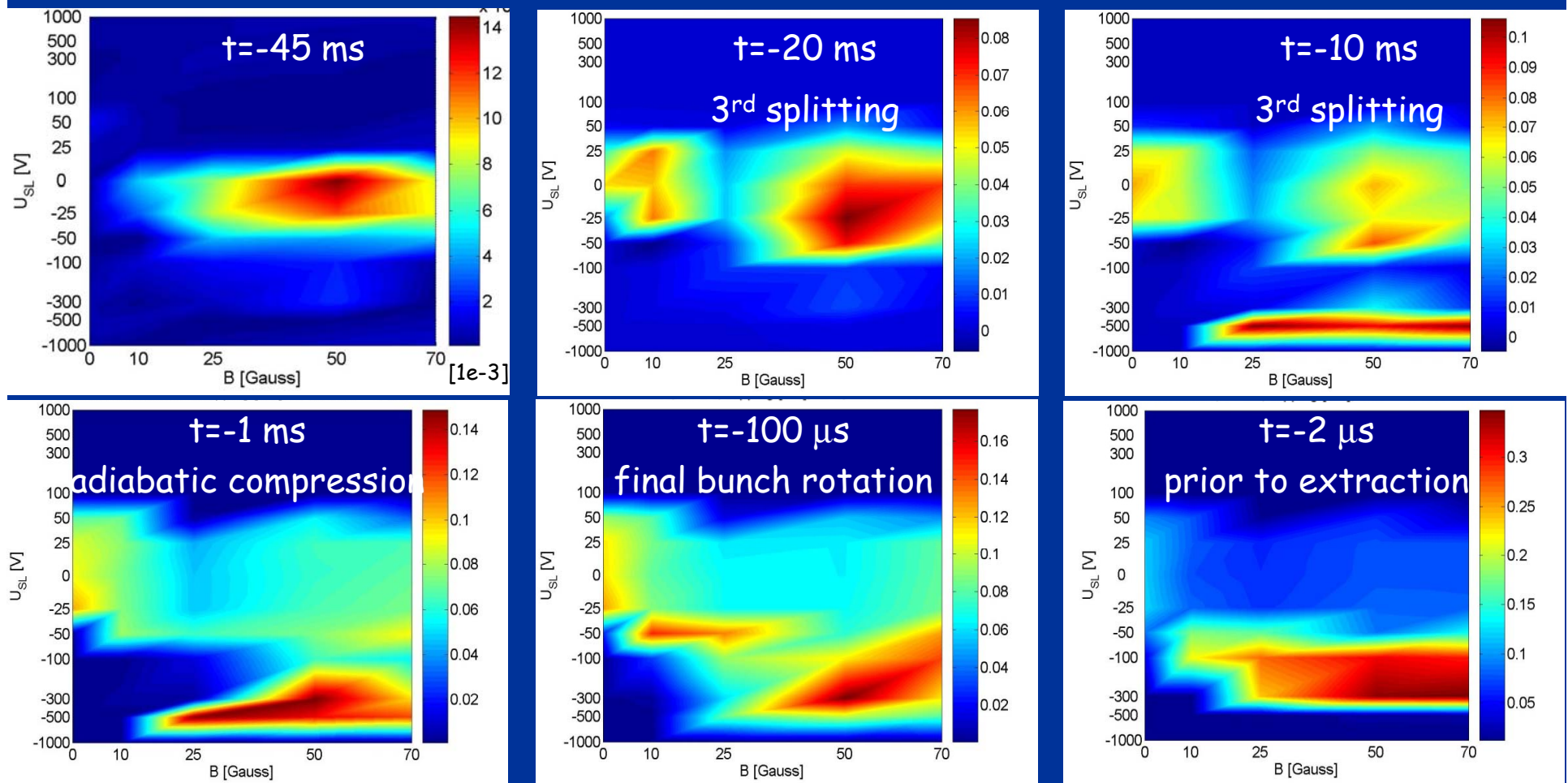


- PS elliptical vacuum chamber with dimensions 1050 x 146 x 70 mm.
- Special antechamber for clearing electrode without aperture reduction.
- Material: stainless steel 316 LN

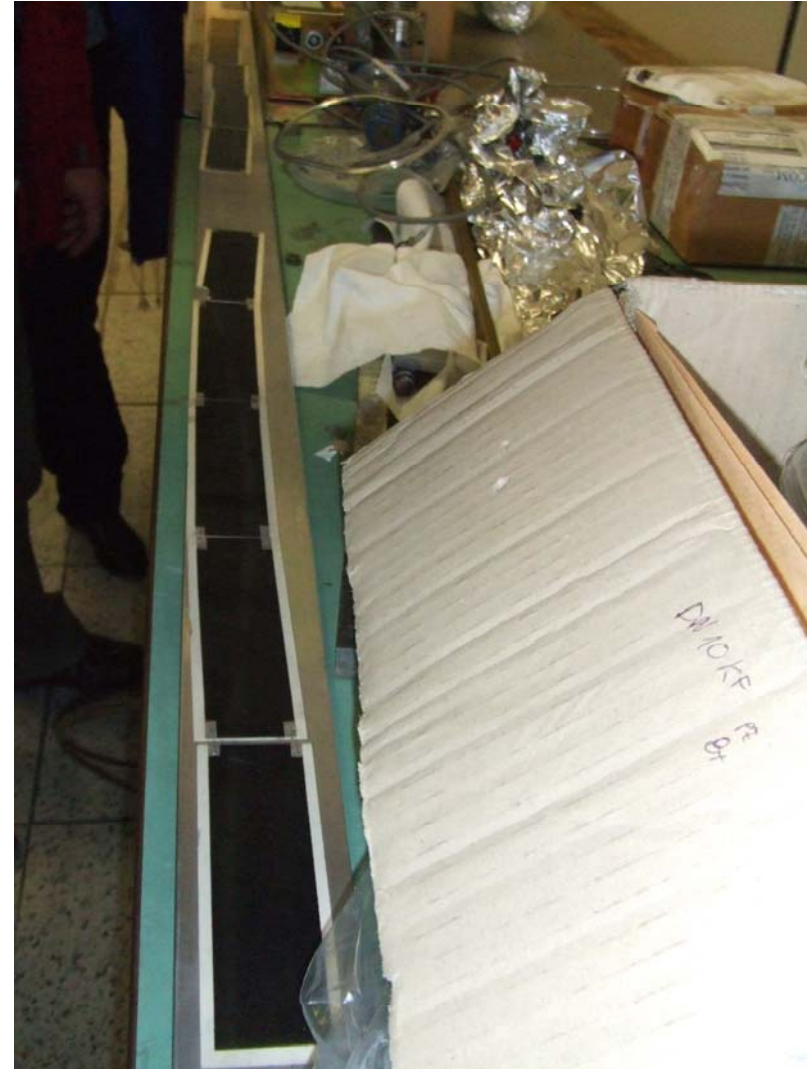


2007 PS results: "islands" w. surviving EC

- e- signal plotted at different times before ejection
- e- build-up earlier with magnetic field; e- "islands"
- for large clearing voltages ($|U| > 1$ kV) e- are suppressed



conventional “invisible” clearing electrode at DAFNE
- major impedance! - now removed from the ring



F. Zimmermann, ECL2; M. Zobov, ECL2

“e- cloud killer” prototyped by Texas A&M

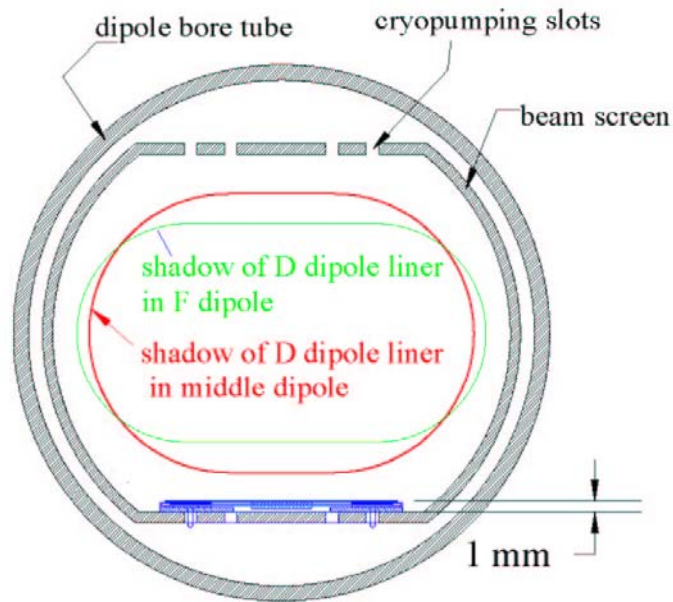


Figure 1. ECE electrode assembly (blue) on base of beam screen. Shadows of the beam screen from the D dipole are shown at the F dipole (green) and middle dipole (red).

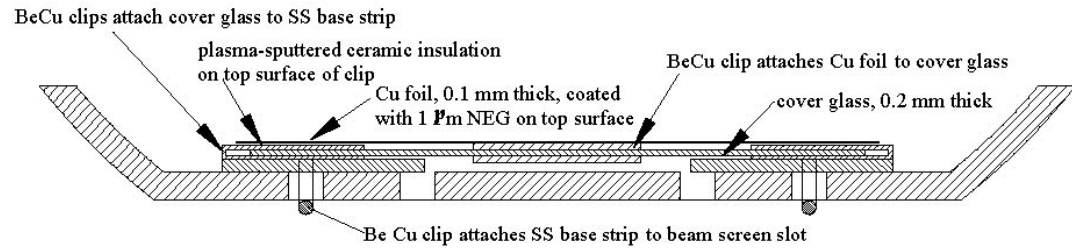


Figure 2. Detail of ECE electrode assembly.

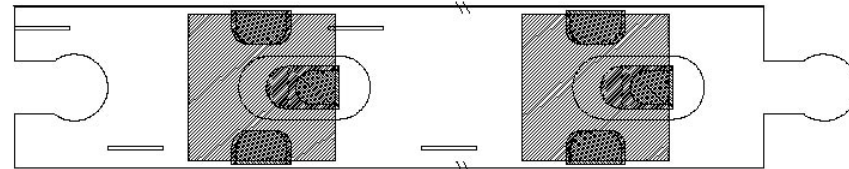


Figure 3. Plan view of a segment of the ECE electrode, showing attachment of Cu electrode to SS skid.

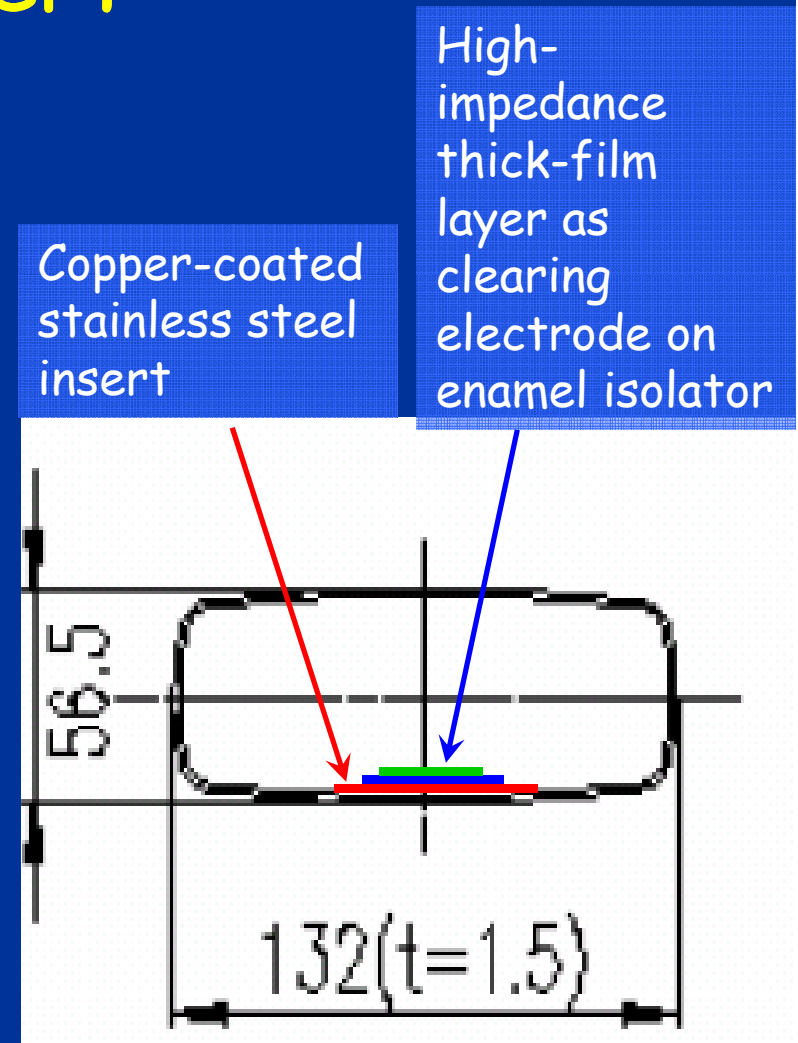
NEG-coated 100- μ m copper-foil electrode with 100-V bias voltage; insulation by 0.2 mm cover glass

enamel coating – the new “e- cloud killer”
(F. Caspers, F.-J. Behler, P. Hellmold, J. Wendel, ECL2)



proposed enamel solution for SPS: a strip insert

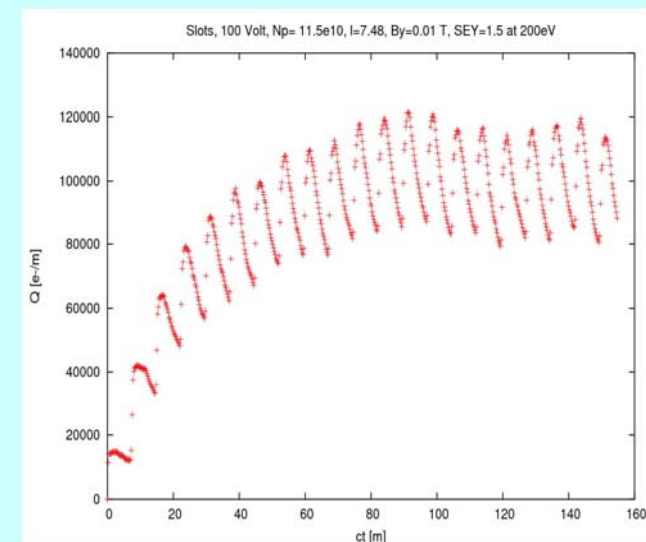
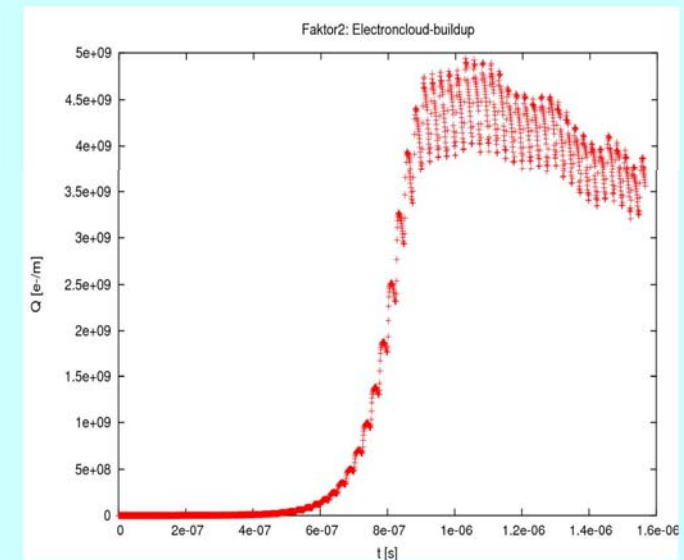
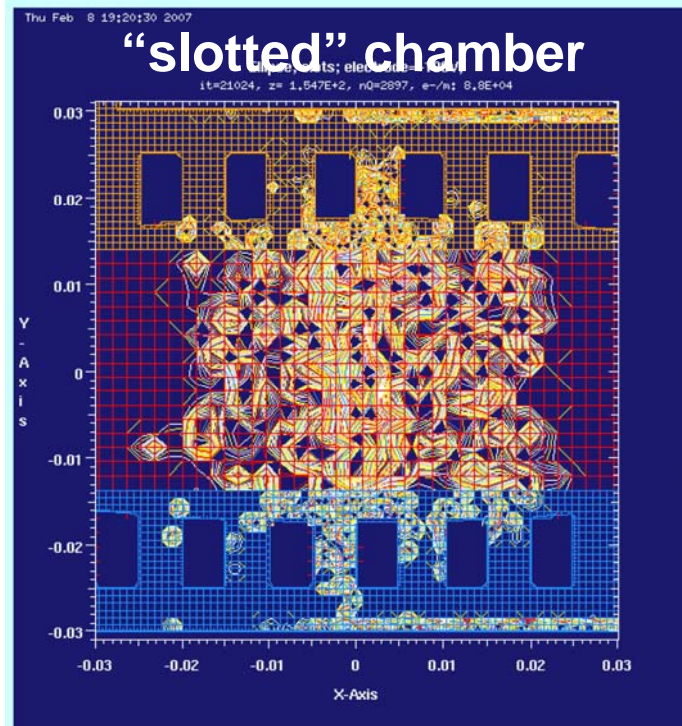
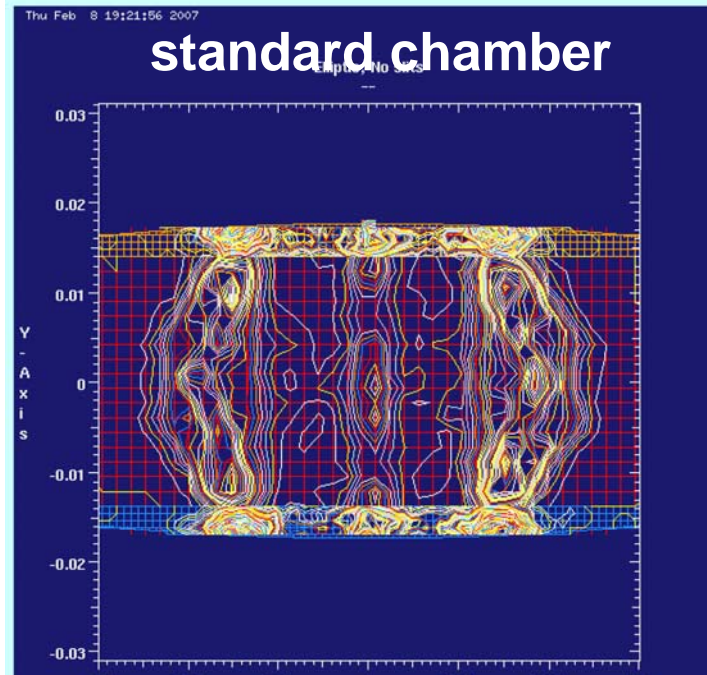
- 0.5 mm stainless steel sheet
- copper coating
- ~20 mm wide and ~0.1 mm thick enamel strip
- on top ~15 μm highly resistive thick film layer acting as "invisible" clearing electrode
- spot-welded to beam pipe



“slotted”
surface

grid-like
structure
shields
beam fields
at the wall

this effect
may explain
why ISIS
never
observed
e-cloud



W. Bruns, ECL2

electretes

- another solution proposed by Fritz Caspers at ECL2
- electrete = **permanently charged material**,
e.g. teflon subjected to e-
bombardment during production
- either permanent electric field is **sustained over several years**, or **self-charging by the beam field**
- may allow **in-situ upgrade** of LHC and SPS!

ECL2: pros and cons – electrodes vs NEG

clearing electrode	NEG
install once	regular activation needed
never demonstrated??	demonstrated in many machines
for ions: shaking + clearing helpful	good for vacuum
efficient for ISR coasting beam e-	long-term stability?
impedance?	

possible solutions for new LHC injectors

PS2	SPS with PS2
slotted chamber enamel electrodes electrete insert NEG coating	NEG coating TiN coating in-situ grooves electrete insert enamel inserts

possible solutions for new LHC injectors

PS2	SPS with PS2
<p>slotted chamber enamel electrodes electrete insert NEG coating</p>	<p>NEG coating TiN coating in-situ grooves electrete insert enamel inserts</p>

entirely new machine

aperture constraints in existing magnets



summary



- numerous technological concepts for suppressing e-cloud build up
- enamel clearing electrodes and slotted chambers: novel promising concepts
- TiN and NEG coating: still considered
- additional constraints retrofitting an existing accelerator like the SPS
- electrode clearing effect explored at PS
- studies for PS2 & enhanced SPS vacuum chambers progress at high momentum

appendix

- open questions from ECL2
- SEY conditioning effect

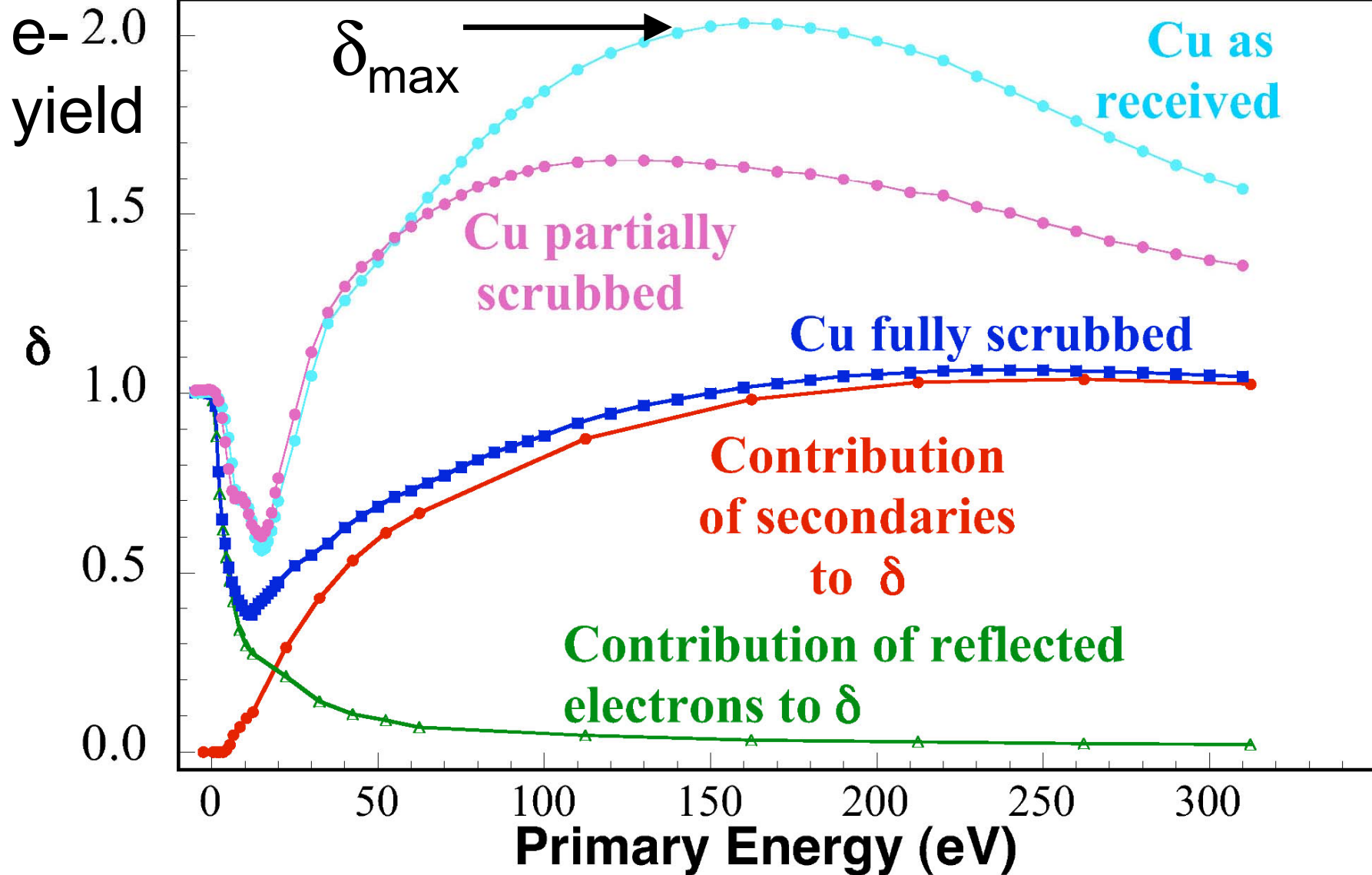
open questions from ECL2

- **modeling of electron cloud & e- emission**
 - **effect of beam field, magnetic field**, and ions
 - many **questions on grooves**
 - **surface** parameters (e.g. Cu-st.st. difference)
- **enamel**
 - **SEY and PEY, impedance, stability**
 - study suppression efficiency
 - can enamel coating fit into SPS chamber?
- **air baked Cu, radical injection, permanent el. fields**
- **in-situ grooving?**
- **NEG, TiN – long term stability, self-activation, heat**

surface physics of secondary emission yield (SEY)

- important role of **surface hydrocarbons**
- after limited air exposure and **(re-)conditioning by e-bombardment** (typically $10^{-3}\text{C}/\text{mm}^2$) maximum SEY of TiN decreases to 1-1.2 ; and for copper to 1.2-1.3
- two phenomena contribute to conditioning:
 - particle stimulated **desorption** (H, CO..) and surface cleaning
 - **graphitization** of adsorbed hydrocarbons

secondary



probability of elastic electron reflection may approach 1
for zero incident energy and is \sim independent of δ_{max}^*